

# HAT2050T

Silicon N Channel Power MOS FET  
High Speed Power Switching

**HITACHI**

ADE-208-660A (Z)

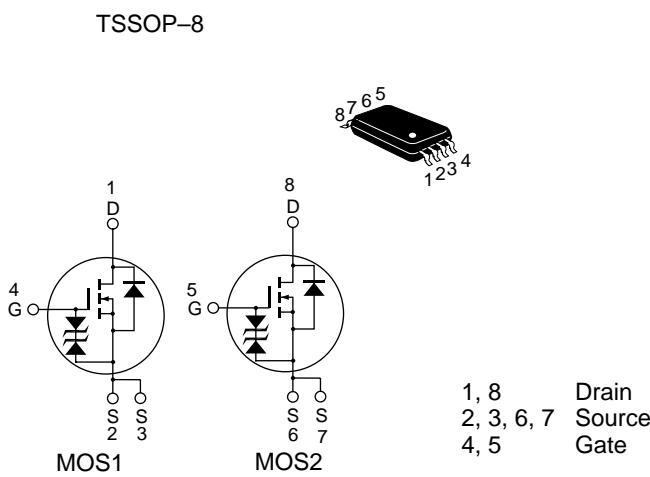
2nd. Edition

February 1999

## Features

- Low on-resistance
- Capable of 4 V gate drive
- Low drive current
- High density mounting

## Outline



## Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	100	V
Gate to source voltage	$V_{GSS}$	$\pm 20$	V
Drain current	$I_D$	1	A
Drain peak current	$I_{D(\text{pulse})}$ <sup>Note1</sup>	4	A
Body-drain diode reverse drain current	$I_{DR}$	1	A
Channel dissipation	$P_{ch}$ <sup>Note2</sup>	1.0	W

Item	Symbol	Ratings	Unit
Channel dissipation	Pch Note3	1.5	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	- 55 to + 150	°C

Note: 1.PW ≤ 10μs, duty cycle ≤ 1 %

2.1 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW≤ 10s

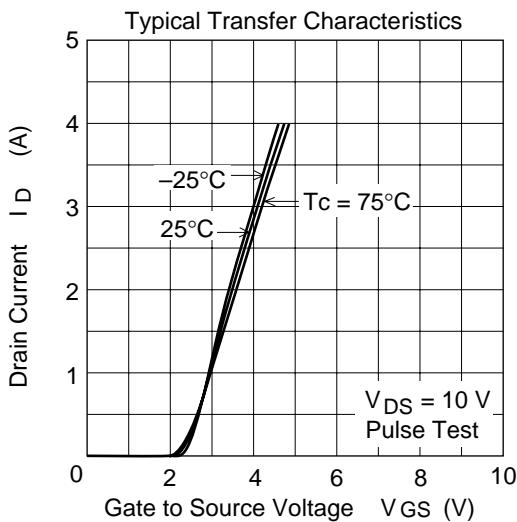
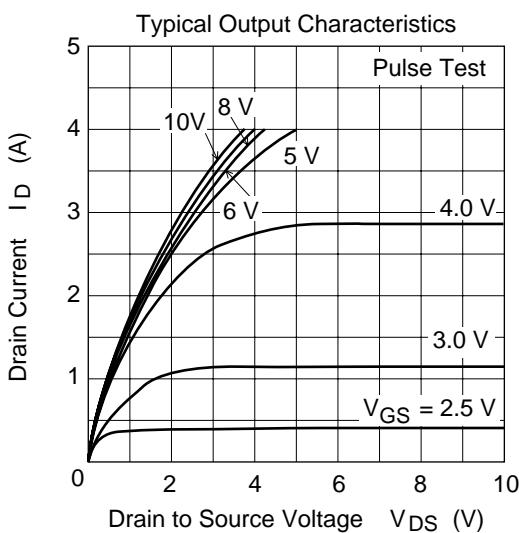
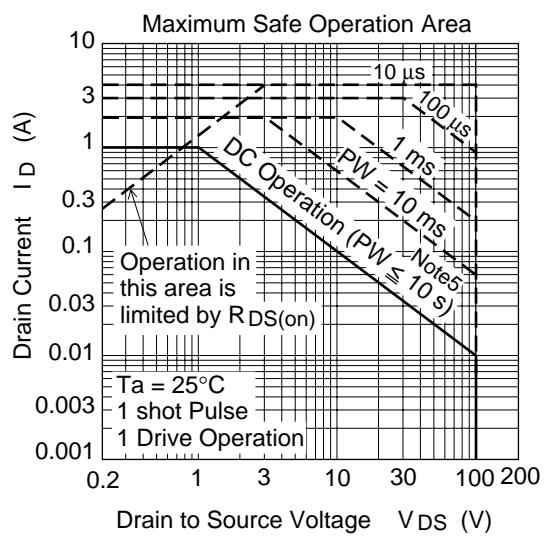
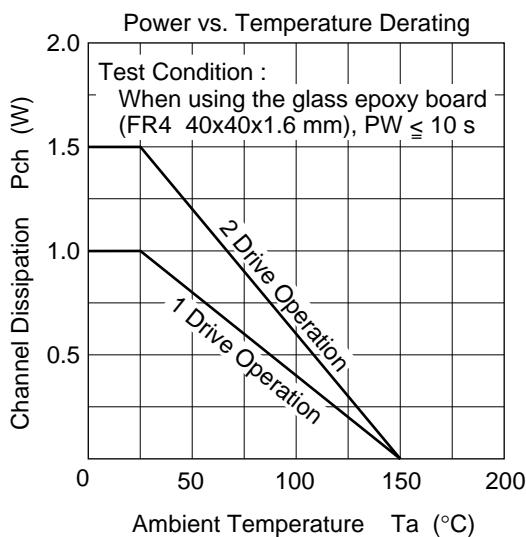
2 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW≤ 10s

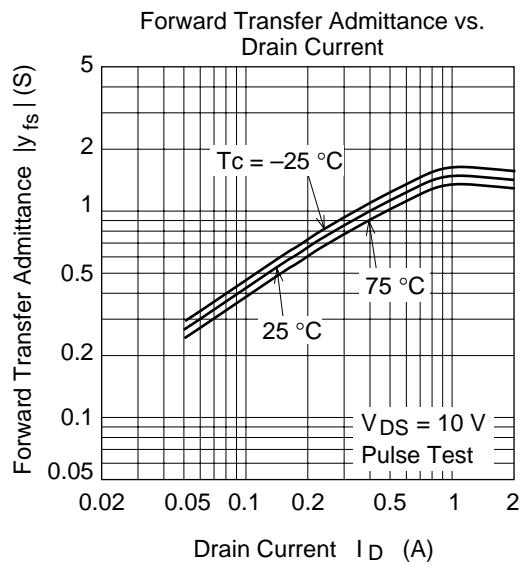
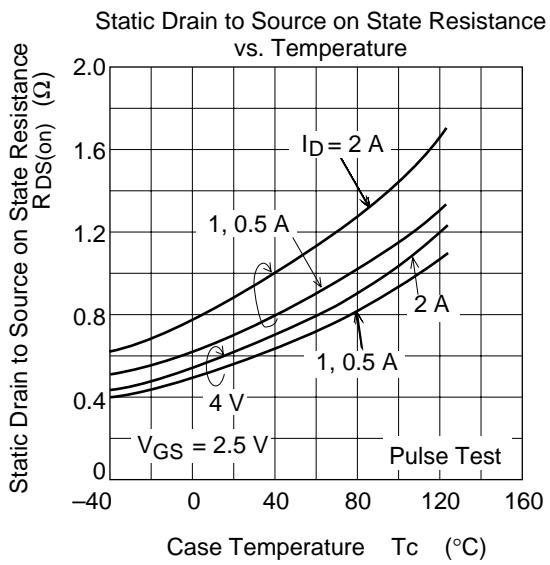
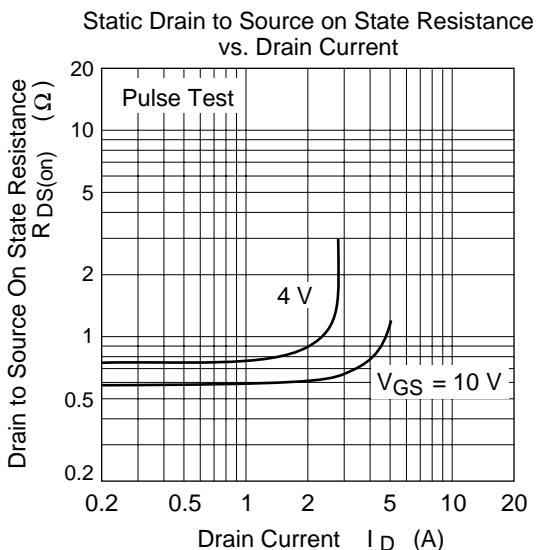
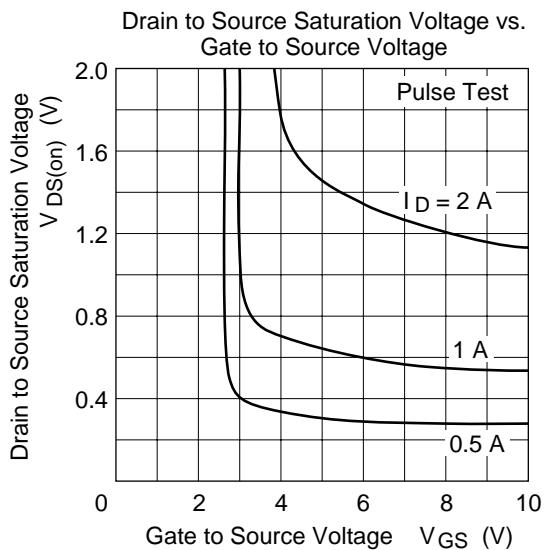
**Electrical Characteristics (Ta = 25°C)**

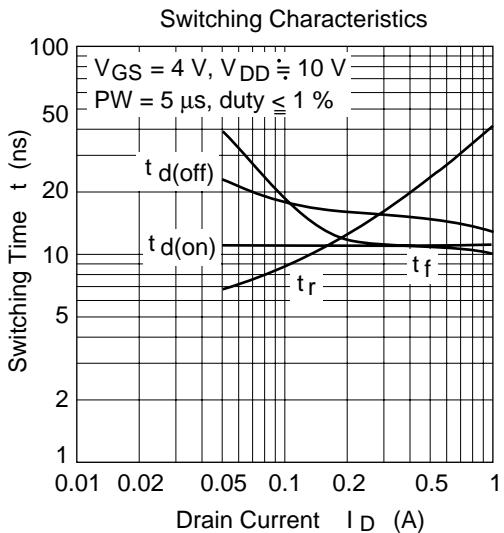
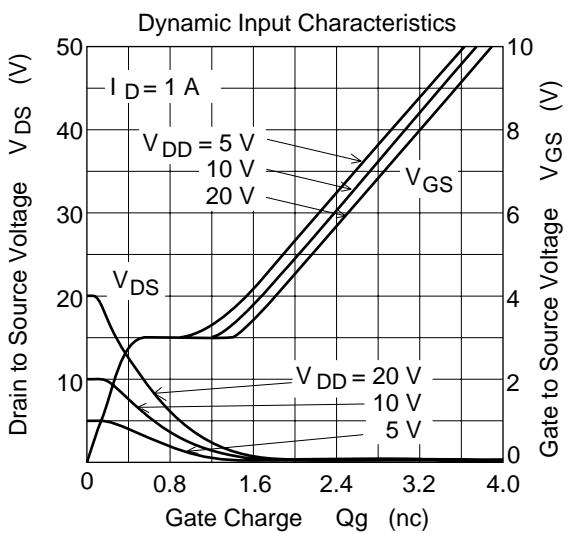
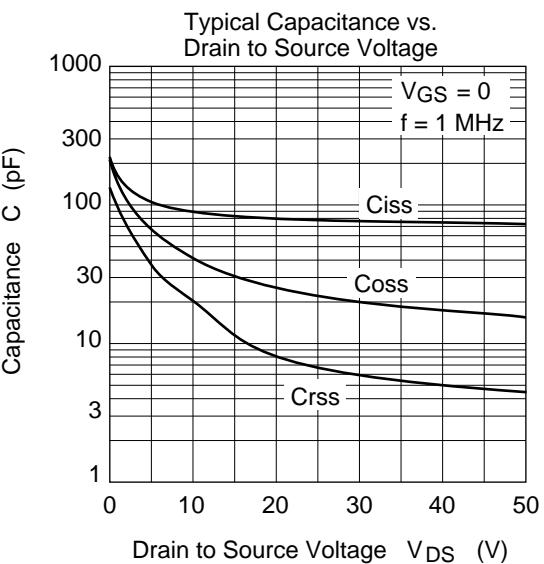
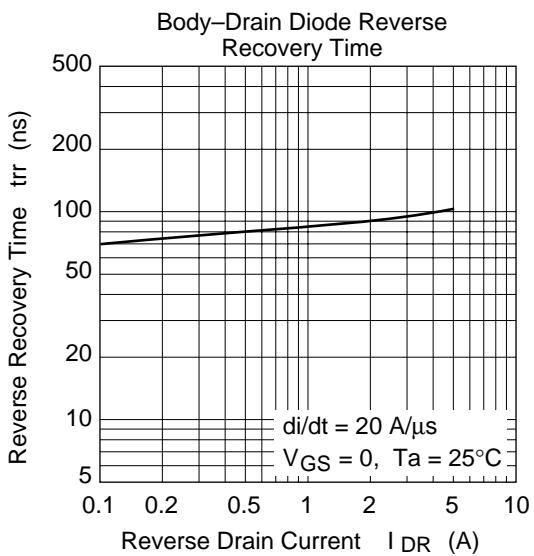
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage S	V <sub>(BR)DS</sub>	100	—	—	V	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage S	V <sub>(BR)GS</sub>	± 20	—	—	V	I <sub>G</sub> = ± 100 μA, V <sub>DS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	—	—	± 10	μA	V <sub>GS</sub> = ± 16 V, V <sub>DS</sub> = 0
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	1	μA	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.3	—	2.3	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Static drain to source on state resistance	R <sub>DS(on)</sub>	—	0.56	0.75	Ω	I <sub>D</sub> = 0.5 A, V <sub>GS</sub> = 10 V Note4
Forward transfer admittance	y <sub>fs</sub>	0.7	1.1	—	S	I <sub>D</sub> = 0.5 A, V <sub>DS</sub> = 10 V Note4
Input capacitance	C <sub>iss</sub>	—	90	—	pF	V <sub>DS</sub> = 10 V
Output capacitance	C <sub>oss</sub>	—	42	—	pF	V <sub>GS</sub> = 0
Reverse transfer capacitance	C <sub>rss</sub>	—	20	—	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	—	11	—	ns	V <sub>GS</sub> = 4 V, I <sub>D</sub> = 0.5 A
Rise time	t <sub>r</sub>	—	24	—	ns	V <sub>DD</sub> @ 10 V
Turn-off delay time	t <sub>d(off)</sub>	—	14	—	ns	
Fall time	t <sub>f</sub>	—	11	—	ns	
Body-drain diode forward voltage	V <sub>DF</sub>	—	0.84	1.1	V	I <sub>F</sub> = 1 A, V <sub>GS</sub> = 0 Note4
Body-drain diode reverse recovery time	t <sub>rr</sub>	—	85	—	ns	I <sub>F</sub> = 1 A, V <sub>GS</sub> = 0 diF/dt = 20 A/μs

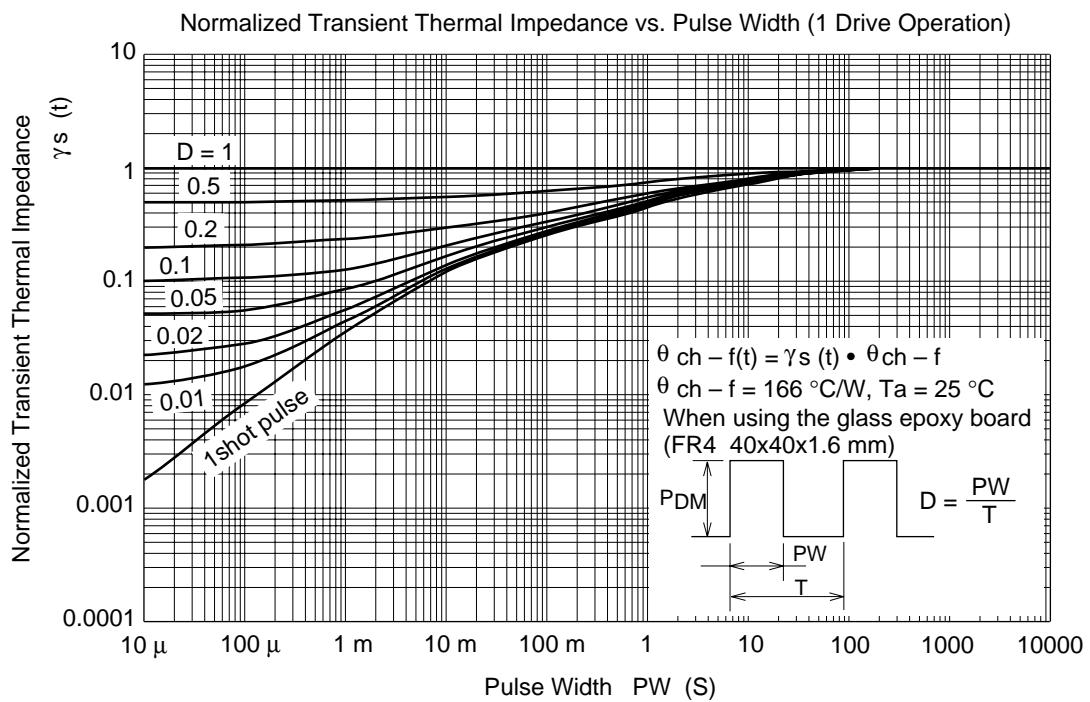
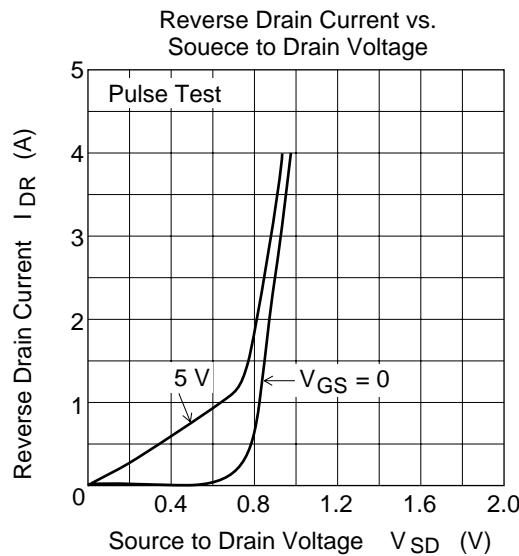
Note: 4.Pulse test

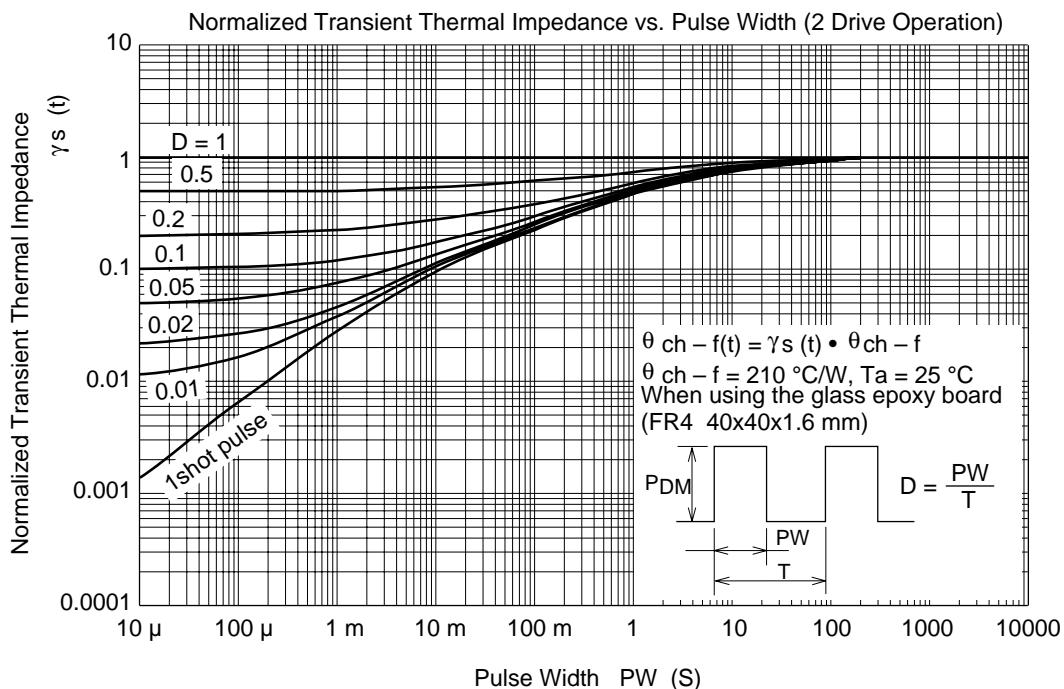
## Main Characteristics



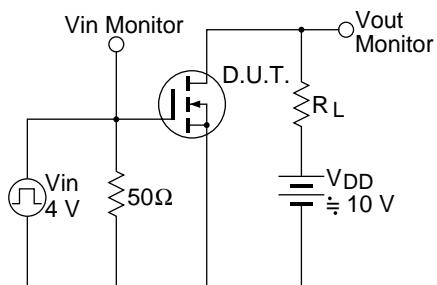




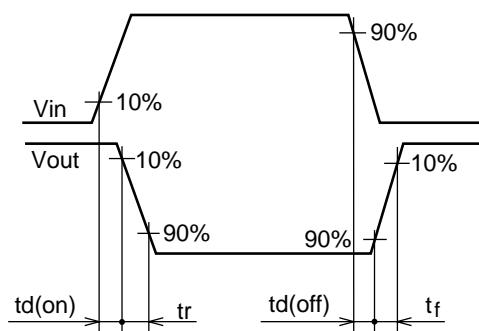




Switching Time Test Circuit

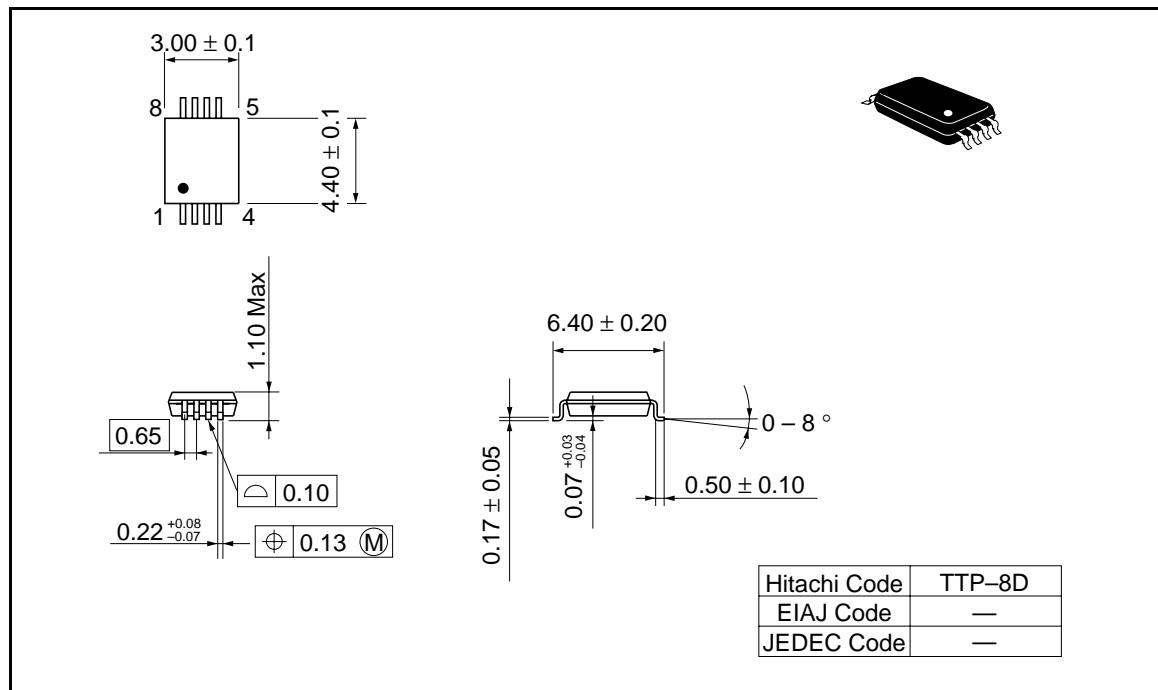


Switching Time Waveform



## Package Dimensions

Unit: mm



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